

**Vishay Siliconix** 

## Dual N-Channel 30 V (D-S) MOSFET

| PRODUCT SUMMARY     |                                  |                                 |                       |  |  |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|
| V <sub>DS</sub> (V) | R <sub>DS(on)</sub> (Ω)          | I <sub>D</sub> (A) <sup>a</sup> | Q <sub>g</sub> (Typ.) |  |  |
| 30                  | 0.0195 at V <sub>GS</sub> = 10 V | 8.5                             | 7.1                   |  |  |
|                     | 0.023 at V <sub>GS</sub> = 4.5 V | 8.6                             | 7.1                   |  |  |

#### **FEATURES**

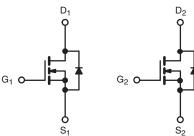
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Notebook System Power
- Low Current DC/DC



SO-8  $S_1$ D1 8 G<sub>1</sub> Dı  $S_2$  $D_2$ 6  $G_2$ 5  $D_2$ Top View





Ordering Information: Si4214DDY-T1-E3 (Lead (Pb)-free)

N-Channel MOSFET

N-Channel MOSFET

#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted) Parameter Symbol Limit Unit Drain-Source Voltage $V_{DS}$ 30 v V<sub>GS</sub> Gate-Source Voltage ± 20 T<sub>C</sub> = 25 °C 8.5 T<sub>C</sub> = 70 °C 7.5 Continuous Drain Current (T<sub>J</sub> = 150 °C) $I_D$ T<sub>A</sub> = 25 °C 7.5<sup>b, c</sup> T<sub>A</sub> = 70 °C 5.9<sup>b, c</sup> Pulsed Drain Current I<sub>DM</sub> 30 А T<sub>C</sub> = 25 °C 2.8 $I_{S}$ Source-Drain Current Diode Current T<sub>A</sub> = 25 °C 1.8<sup>b, c</sup> Pulsed Source-Drain Current I<sub>SM</sub> 30 Single Pulse Avalanche Current 10 I<sub>AS</sub> L = 0.1 mHSingle Pulse Avalanche Energy E<sub>AS</sub> 5 T<sub>C</sub> = 25 °C 3.1 T<sub>C</sub> = 70 °C 2.0 Maximum Power Dissipation $\mathsf{P}_\mathsf{D}$ w $T_A = 25 \ ^{\circ}C$ 2.0<sup>b, c</sup> T<sub>A</sub> = 70 °C 1.25<sup>b, c</sup> Operating Junction and Storage Temperature Range °C T<sub>J</sub>, T<sub>stg</sub> - 55 to 150

| THERMAL RESISTANCE RATINGS                  |              |                   |      |      |      |  |  |
|---|--------------|-------------------|------|------|------|--|--|
| Parameter                                   |              | Symbol            | Тур. | Max. | Unit |  |  |
| Maximum Junction-to-Ambient <sup>b, d</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 52   | 62.5 | °C/W |  |  |
| Maximum Junction-to-Foot (Drain)            | Steady-State | R <sub>thJF</sub> | 30   | 40   | 0/11 |  |  |

Notes:

a. Based on  $T_C = 25$  °C.

b. Surface mounted on 1" x 1" FR4 board.  $c_{1} t = 10 s_{2}$ 

d. Maximum under steady state conditions is 110 °C/W.

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|   |                         | erwise noted)<br>Test Conditions  | M:m  | Tree  | Max    | 41 سال |  |
|---|-------------------------|---|------|-------|--------|--------|--|
| Parameter<br>Static                           | Symbol                  | lest Conditions   | Min. | Тур.  | Max.   | Unit   |  |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>         | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA  | 30   |       | [      | V      |  |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$   | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA  | 30   | 2.0   |        | v      |  |
|   |                         | 5 ,   |      | 3.0   |        | mV/°C  |  |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$ | $I_{\rm D} = 250 \mu {\rm A}$   | 1.0  | - 5.2 | 0.5    |        |  |
| Gate Threshold Voltage                        | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$  | 1.2  |       | 2.5    | V      |  |
| Gate-Body Leakage                             | I <sub>GSS</sub>        | $V_{DS} = 0 V, V_{GS} = \pm 20 V$   |      |       | 100    | nA     |  |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>        | $V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$   |      |       | 1      | μΑ     |  |
|   |                         | $V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ TJ} = 55 ^{\circ}\text{C}$         |      |       | 10     | · ·    |  |
| On -State Drain Current <sup>b</sup>          | I <sub>D(on)</sub>      | $V_{DS} = 5 V, V_{GS} = 10 V$   | 20   |       |        | A      |  |
| Drain-Source On-State Resistance <sup>b</sup> | R <sub>DS(on)</sub>     | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A  |      | 0.016 | 0.0195 | Ω      |  |
|   | D3(01)                  | $V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$   |      | 0.019 | 0.023  |        |  |
| Forward Transconductance <sup>b</sup>         | 9 <sub>fs</sub>         | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 8 A  |      | 27    |        | S      |  |
| Dynamic <sup>a</sup>                          |                         |   |      |       |        |        |  |
| Input Capacitance                             | C <sub>iss</sub>        |   |      | 660   |        | pF     |  |
| Output Capacitance                            | C <sub>oss</sub>        | $V_{DS}$ = 15 V, $V_{GS}$ = 0 V, $I_{D}$ = 1 MHz  |      | 140   |        |        |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>        |   |      | 86    |        |        |  |
| Tatal Cata Charge                             | Qg                      | $V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$             |      | 14.5  | 22     | nC     |  |
| Total Gate Charge                             |                         |   |      | 7.1   | 11     |        |  |
| Gate-Source Charge                            | Q <sub>gs</sub>         | $V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8 \text{ A}$            |      | 1.9   |        |        |  |
| Gate-Drain Charge                             | Q <sub>gd</sub>         |   |      | 2.7   |        |        |  |
| Gate Resistance                               | R <sub>g</sub>          | f = 1 MHz   | 0.5  | 2.6   | 5.2    | Ω      |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |      | 14    | 28     | -      |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 15 V, $R_L$ = 3 $\Omega$   |      | 45    | 80     |        |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D \cong 5$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$  |      | 18    | 35     |        |  |
| Fall Time                                     | t <sub>f</sub>          |   |      | 12    | 24     |        |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |      | 7     | 14     | ns     |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD} = 15 \text{ V}, \text{ R}_1 = 3 \Omega$   |      | 10    | 20     | -      |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D \cong 5 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$ |      | 15    | 30     |        |  |
| Fall Time                                     | t <sub>f</sub>          |   |      | 7     | 14     |        |  |
| Drain-Source Body Diode Characterist          |                         | 11  |      | I     |        |        |  |
| Continuous Source-Drain Diode Current         | ا <sub>S</sub>          | T <sub>C</sub> = 25 °C  |      |       | 2.8    |        |  |
| Pulse Diode Forward Current <sup>a</sup>      | I <sub>SM</sub>         |   |      |       | 30     | A      |  |
| Body Diode Voltage                            | V <sub>SD</sub>         | I <sub>S</sub> = 2 A  |      | 0.77  | 1.1    | V      |  |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>         |   |      | 17    | 34     | ns     |  |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>         | 1 F   |      | 9     | 18     | nC     |  |
| Reverse Recovery Fall Time                    | t <sub>a</sub>          | $I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$ |      | 10    |        |        |  |
| Reverse Recovery Rise Time                    | t <sub>a</sub>          | —   |      | 7     |        | nS     |  |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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55 °C

4

5

T<sub>C</sub> =

3

18

 $V_{GS} = 10 V$ 

50

75

100

24

V<sub>GS</sub> = 4.5 V

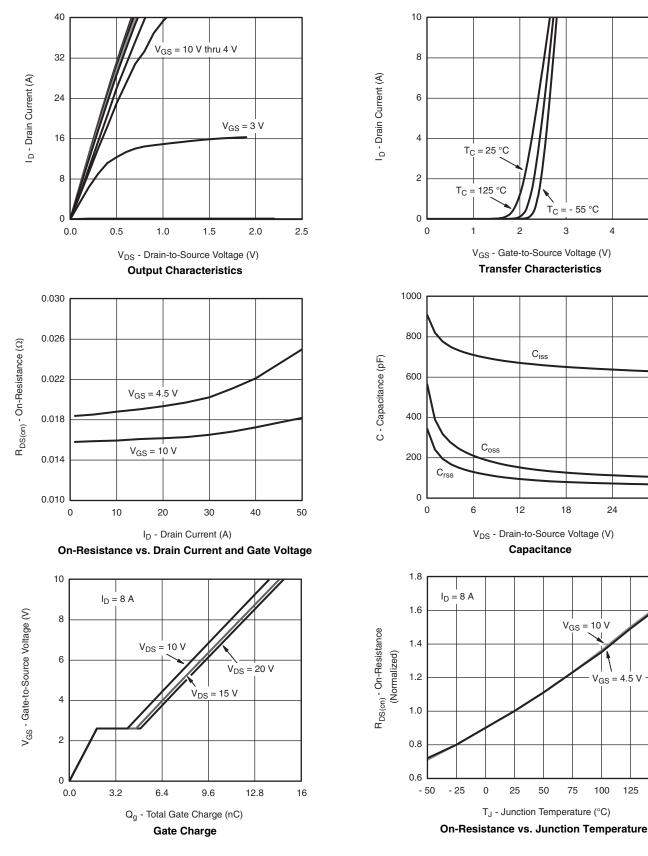
30

2

 $\mathbf{C}_{\text{iss}}$ 

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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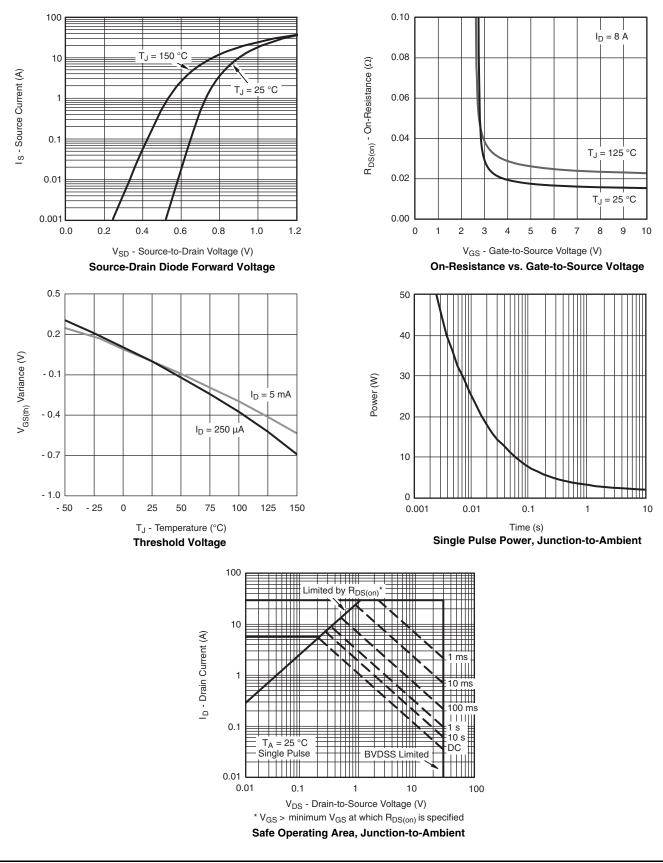
150

3

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

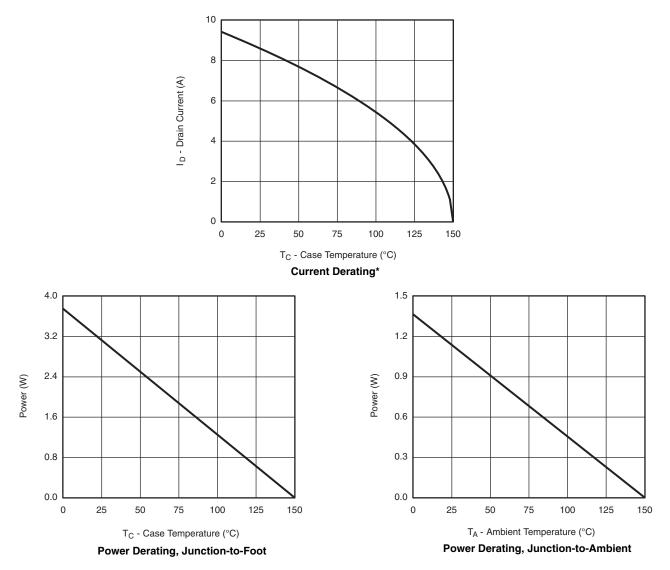


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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

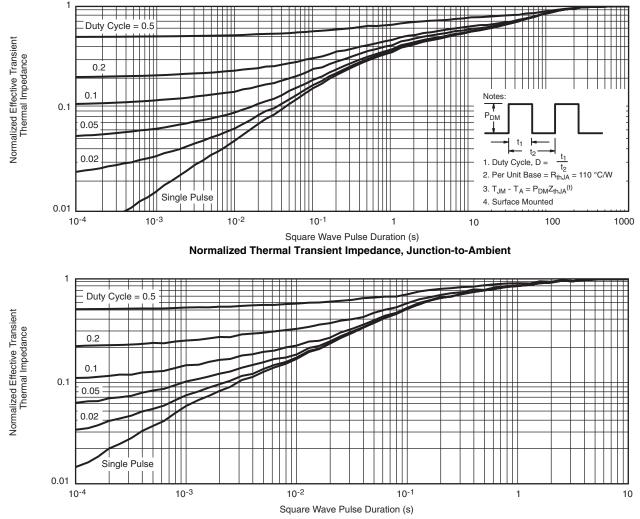


\* The power dissipation P<sub>D</sub> is based on T<sub>J(max)</sub> = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations.

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## Package Information

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# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





|   | MILLIMETERS |      | INCHES    |       |  |
|---|-------------|------|-----------|-------|--|
| DIM   | Min         | Мах  | Min       | Max   |  |
| A   | 1.35        | 1.75 | 0.053     | 0.069 |  |
| A <sub>1</sub>                              | 0.10        | 0.20 | 0.004     | 0.008 |  |
| В   | 0.35        | 0.51 | 0.014     | 0.020 |  |
| С   | 0.19        | 0.25 | 0.0075    | 0.010 |  |
| D   | 4.80        | 5.00 | 0.189     | 0.196 |  |
| E   | 3.80        | 4.00 | 0.150     | 0.157 |  |
| е   | 1.27 BSC    |      | 0.050 BSC |       |  |
| н   | 5.80        | 6.20 | 0.228     | 0.244 |  |
| h   | 0.25        | 0.50 | 0.010     | 0.020 |  |
| L   | 0.50        | 0.93 | 0.020     | 0.037 |  |
| q   | 0°          | 8°   | 0°        | 8°    |  |
| S   | 0.44        | 0.64 | 0.018     | 0.026 |  |
| ECN: C-06527-Rev. I, 11-Sep-06<br>DWG: 5498 |             |      |           |       |  |

## **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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